



DMTH6004SK3

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max Tc = +25°C (Note 9)
60V	$3.8m\Omega @ V_{GS} = 10V$	100A

### Description

This MOSFET is designed to minimize the on-state resistance  $(R_{DS(ON)})$ , yet maintain superior switching performance, making it ideal for high efficiency power management applications.

# Applications

- Engine Management Systems
- Body Control Electronics
- DC-DC Converters
- Motor Control

### 60V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET

#### Features

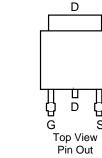
- Rated to +175°C Ideal For High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low R<sub>DS(ON)</sub> Minimizes Power Losses
- Low Q<sub>G</sub> Minimizes Switching Losses
- Lead-Free Finish; RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (<u>DMTH6004SK3Q</u>)

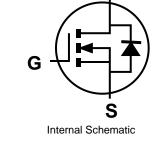
## **Mechanical Data**

- Case: TO252 (DPAK)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
  Solderable per MIL-STD-202, Method 208 (€3)
- Weight: 0.33 grams (Approximate)



TO252 (DPAK)





## Ordering Information (Note 4)

Part Number	Case	Packaging
DMTH6004SK3-13	TO252 (DPAK)	2,500/Tape & Reel

Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**



**DII** =Manufacturer's Marking T6004S = Product Type Marking Code YYWW = Date Code Marking YY = Last Digit of Year (ex: 15 = 2015) WW = Week Code (01 to 53)



## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units	
Drain-Source Voltage	V <sub>DSS</sub>	60	V	
Gate-Source Voltage		V <sub>GSS</sub>	±20	V
Continuous Drain Current (Note 6)	T <sub>C</sub> = +25°C (Note 9)	ID	100	A
	$T_{C} = +100^{\circ}C$		75	
Maximum Body Diode Forward Current (Note 6)	T <sub>C</sub> = +25°C	Is	100	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I <sub>DM</sub>	150	А
Avalanche Current, L = 0.2mH		I <sub>AS</sub>	45	A
Avalanche Energy, L = 0.2mH		E <sub>AS</sub>	200	mJ

## **Thermal Characteristics**

Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	PD	3.9	W
Thermal Resistance, Junction to Ambient (Note 5)		R <sub>0JA</sub>	38	°C/W
Total Power Dissipation (Note 6)	T <sub>C</sub> = +25°C	PD	180	W
Thermal Resistance, Junction to Case (Note 6)	•	R <sub>θJC</sub>	0.8	°C/W
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +175	°C

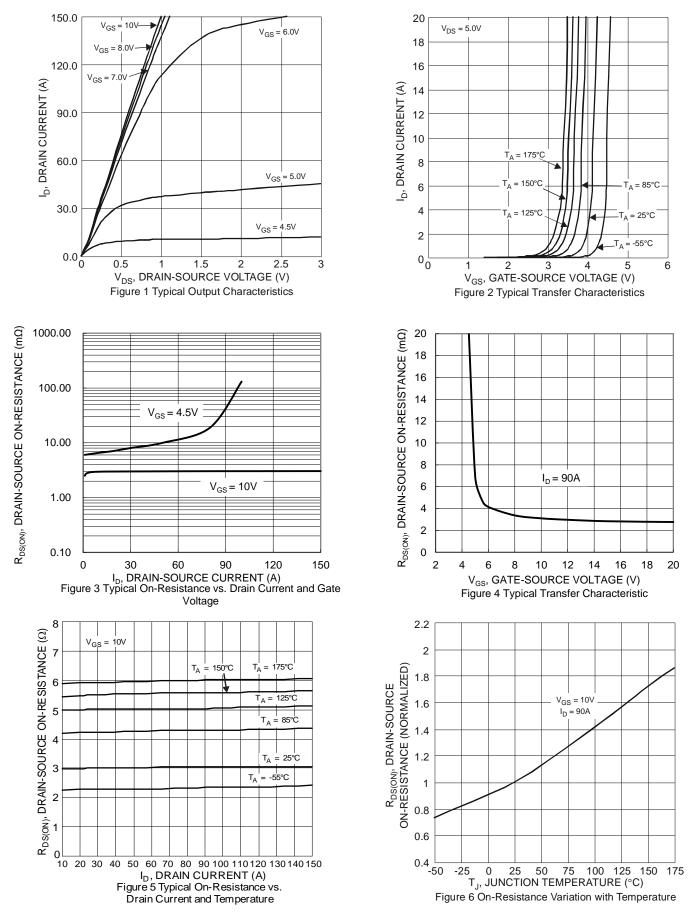
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)				•	•	•	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60		_	V	$V_{GS} = 0V, I_D = 1mA$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μA	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	2	—	4	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	R <sub>DS</sub> (ON)	—	3	3.8	mΩ	$V_{GS} = 10V, I_D = 90A$	
Diode Forward Voltage	V <sub>SD</sub>	_	0.9	1.2	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C <sub>ISS</sub>	_	4,556	_		V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V, f = 1MHz	
Output Capacitance	C <sub>OSS</sub>	_	1,383	_	pF		
Reverse Transfer Capacitance	C <sub>RSS</sub>	_	105.2	_			
Gate Resistance	R <sub>G</sub>	_	0.66	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge	$Q_{G}$	_	95.4	_			
Gate-Source Charge	Q <sub>GS</sub>	_	21.6	—	nC	$V_{DS} = 30V, I_D = 90A, V_{GS} = 10V$	
Gate-Drain Charge	Q <sub>GD</sub>	_	20.4	—			
Turn-On Delay Time	t <sub>D(ON)</sub>	_	13.2	_			
Turn-On Rise Time	t <sub>R</sub>	_	11.7	_		$V_{DD} = 30V, V_{GS} = 10V,$ $I_D = 90A, R_G = 3.5\Omega$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	31	_	ns		
Turn-Off Fall Time	tF	_	12	_	1		
Body Diode Reverse Recovery Time	t <sub>RR</sub>	_	50.5	_	ns		
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>	_	80.8	_	nC	I <sub>F</sub> = 50A, di/dt = 100A/μs	

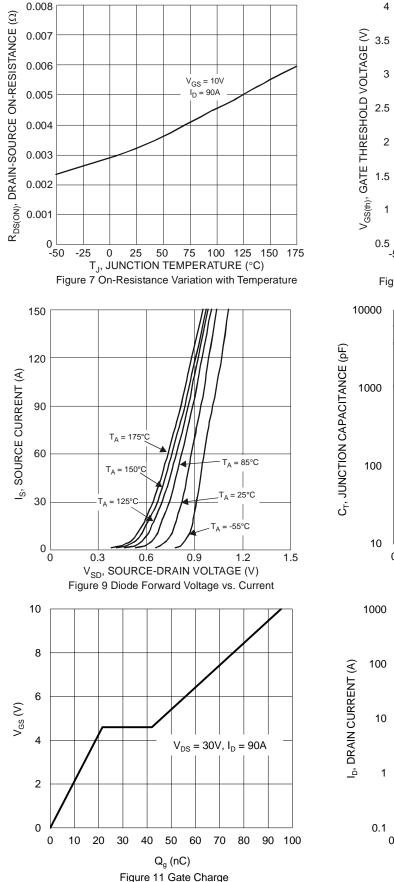
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout.
 Thermal resistance from junction to soldering point (on the exposed drain pad).
 Short duration pulse test used to minimize self-heating effect
 Guaranteed by design. Not subject to production testing
 Package limited. Notes:

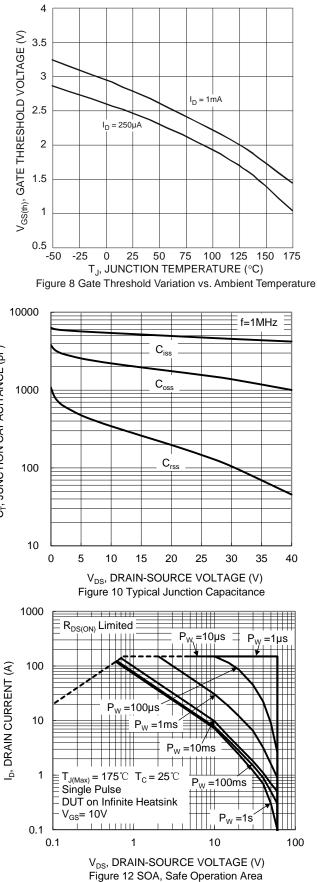


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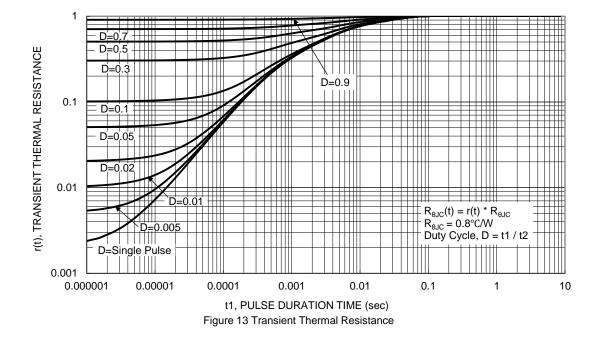








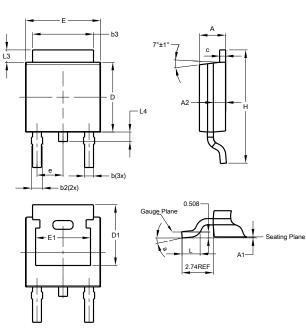






## **Package Outline Dimensions**

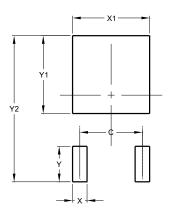
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



TO252 (DPAK)					
Dim	Min	Max	Тур		
Α	2.19	2.39	2.29		
A1	0.00	0.13	0.08		
A2	0.97	1.17	1.07		
b	0.64	0.88	0.783		
b2	0.76	1.14	0.95		
b3	5.21	5.46	5.33		
С	0.45	0.58	0.531		
D	6.00	6.20	6.10		
D1	5.21	-	-		
е	-	-	2.286		
Ε	6.45	6.70	6.58		
E1	4.32	-	-		
Н	9.40	10.41	9.91		
L	1.40	1.78	1.59		
L3	0.88	1.27	1.08		
L4	0.64	1.02	0.83		
а	0°	10°	-		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



#### TO252 (DPAK)

Dimensions	Value (in mm)
С	4.572
Х	1.060
X1	5.632
Y	2.600
Y1	5.700
Y2	10.700

TO252 (DPAK)



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